



# Vincotech

<b>flow3xBOOST 1</b>		<b>1200 V / 80 A</b>
<b>Features</b>		<b>flow 1 12 mm housing</b>
<ul style="list-style-type: none"><li>• High Efficiency Triple Booster</li><li>• Latest IGBT Technology</li><li>• Integrated NTC</li><li>• Compact Design</li><li>• Low inductance housing</li></ul>		
<b>Target applications</b>		<b>Schematic</b>
<ul style="list-style-type: none"><li>• Solar Inverters</li></ul>		
<b>Types</b>		
<ul style="list-style-type: none"><li>• 10-FY123BA080N302-LN28L37</li></ul>		



10-FY123BA080N302-LN28L37

datasheet

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## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Boost Switch</b>				
Collector-emitter voltage	$V_{CES}$		1200	V
Collector current	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	68	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	320	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	138	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Boost Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Continuous (direct) forward current	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	32	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	92	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 8,3 \text{ ms}$ $T_j = 150^\circ\text{C}$	66	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	87	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Boost Sw. Protection Diode

Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward average current	$I_{FAV}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	31	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 150^\circ\text{C}$	200	A
Surge current capability	$I^2t$		200	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	37	W
Maximum junction temperature	$T_{jmax}$		150	$^\circ\text{C}$

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**Vincotech****Maximum Ratings** $T_j = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>ByPass Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward average current	$I_{FAV}$	$T_j = T_{jmax}$	38	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$	270	A
Surge current capability	$P_t$	$T_j = 150 \text{ }^\circ\text{C}$	370	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	47	W
Maximum junction temperature	$T_{jmax}$		150	$^\circ\text{C}$

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**Vincotech****Maximum Ratings** $T_j = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
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**Module Properties**

<b>Thermal Properties</b>				
Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	°C

**Isolation Properties**

Isolation voltage	$V_{isol}$	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	$V_{isol}$	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				min. 12,7	mm
Clearance				8,12	mm
Comparative Tracking Index	CTI			$\geq 200$	

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0008	25	4,5	5,5	6,5	V	
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		80	25 125 150		1,9 2,06 2,11	1,95	V	
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			800	μA	
Gate-emitter leakage current	$I_{GES}$		20	0		25			400	nA	
Internal gate resistance	$r_g$							None		Ω	
Input capacitance	$C_{res}$	$f = 1 \text{ MHz}$	0	20	25			9824		pF	
Output capacitance	$C_{des}$										
Reverse transfer capacitance	$C_{res}$										
Gate charge	$Q_g$		15	600	80	25		424		nC	

#### Thermal

Thermal resistance junction to sink*	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,69		K/W	
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\*Only valid with pre-applied Vincotech thermal interface material.

#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/15	700	45	25		26			
Rise time	$t_r$					125		24			ns
						150		24,5			
Turn-off delay time	$t_{d(off)}$					25		12,5			ns
Fall time	$t_f$					125		14,5			
						150		14			
Turn-on energy (per pulse)	$E_{on}$					25		232			ns
Turn-off energy (per pulse)	$E_{off}$					125		273			
						150		283			
						25		21,91			
						125		95,27			
						150		81,01			
						25		0,842			mWs
						125		0,917			
						150		0,944			
						25		0,98			mWs
						125		1,87			
						150		2,17			



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Boost Diode

#### Static

Forward voltage	$V_F$				20	25 125 150		1,43 1,74 1,84	1,6	V
Reverse leakage current	$I_R$	$V_T = 1200$ V			25 150		20 160	400	$\mu$ A	

#### Thermal

Thermal resistance junction to sink*	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,09		K/W
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\*Only valid with pre-applied Vincotech thermal interface material.

#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=3376$ A/ $\mu$ s $di/dt=3479$ A/ $\mu$ s	0/15	700	45	25 125 150		20,01 20,11 19,96		A
Reverse recovery time	$t_{rr}$					25 125 150		11,89 11,86 12,37		ns
Recovered charge	$Q_r$					25 125 150		0,362 0,34 0,318		$\mu$ C
Reverse recovered energy	$E_{rec}$					25 125 150		0,153 0,138 0,121		mWs
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 125 150		4988 4928 4745		A/ $\mu$ s



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Boost Sw. Protection Diode

#### Static

Forward voltage	$V_F$				18	25 125 150		1,12 1,03 1,02	1,5	V
Reverse leakage current	$I_R$	$V_r = 1600$ V			25 150			100 1000	$\mu$ A	

#### Thermal

Thermal resistance junction to sink*	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,87		K/W
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\*Only valid with pre-applied Vincotech thermal interface material.

### Bypass Diode

#### Static

Forward voltage	$V_F$				28	25 125		1,15 1,1	1,5	V
Reverse leakage current	$I_R$	$V_r = 1600$ V			25 150			100 1000	$\mu$ A	

#### Thermal

Thermal resistance junction to sink*	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,5		K/W
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\*Only valid with pre-applied Vincotech thermal interface material.



10-FY123BA080N302-LN28L37

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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$							5		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

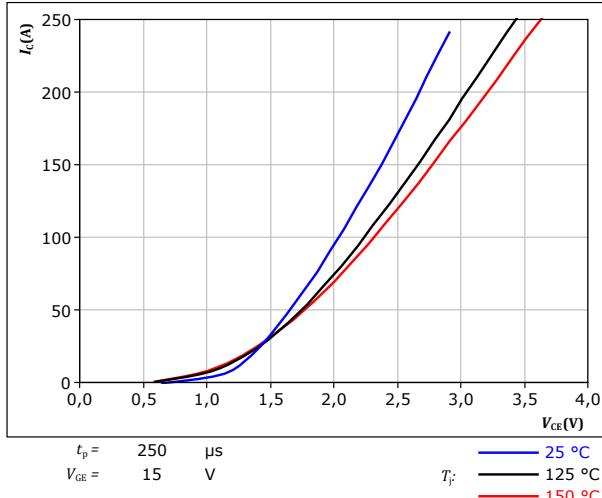


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## Boost Switch Characteristics

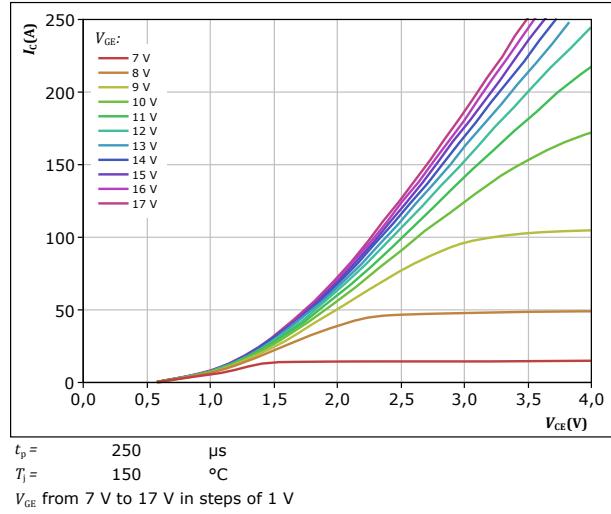
**figure 1.** IGBT

Typical output characteristics  
 $I_C = f(V_{CE})$



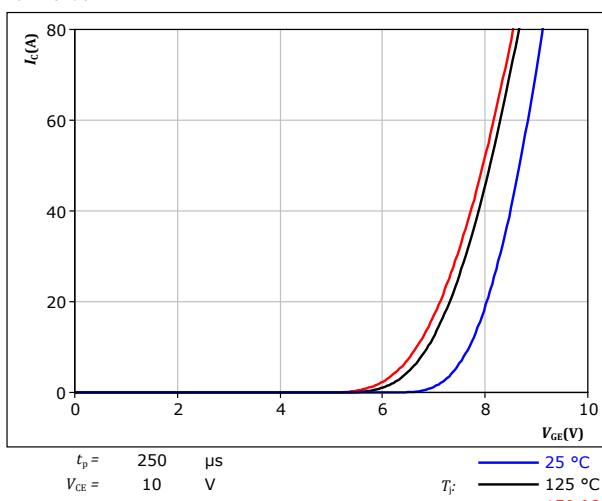
**figure 2.** IGBT

Typical output characteristics  
 $I_C = f(V_{CE})$



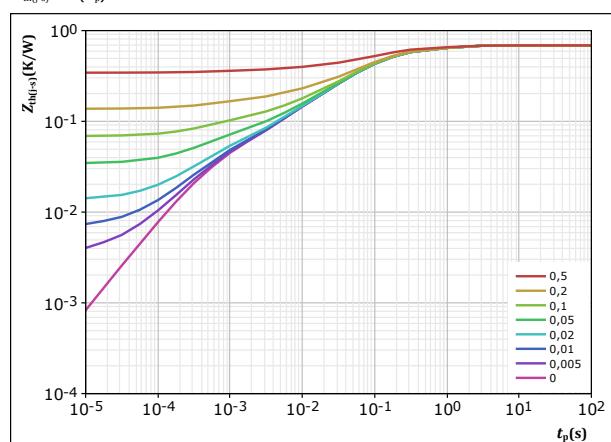
**figure 3.** IGBT

Typical transfer characteristics  
 $I_C = f(V_{GE})$



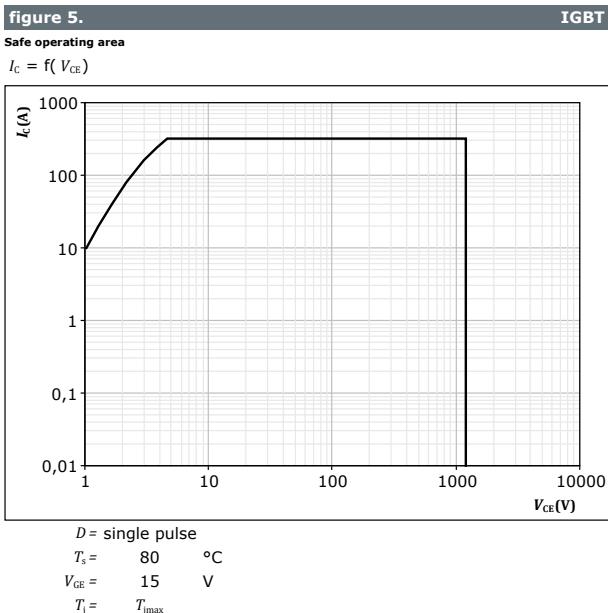
**figure 4.** IGBT

Transient thermal impedance as a function of pulse width  
 $Z_{th(j-s)} = f(t_p)$





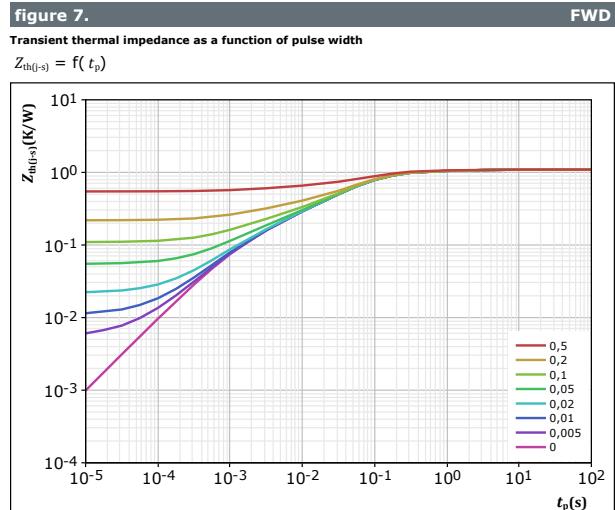
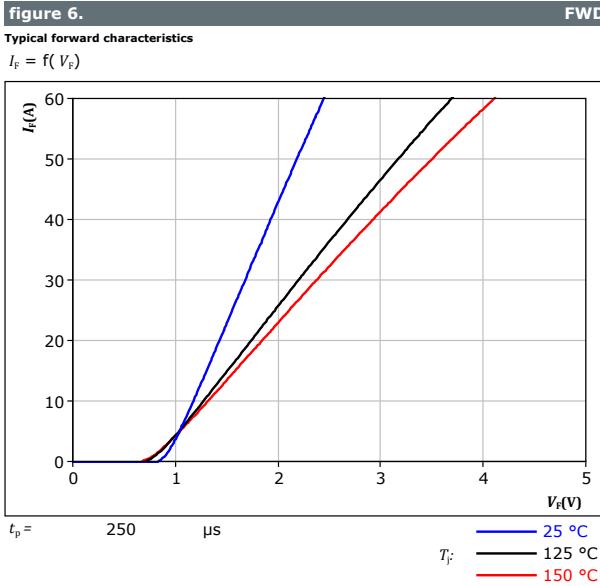
## Boost Switch Characteristics





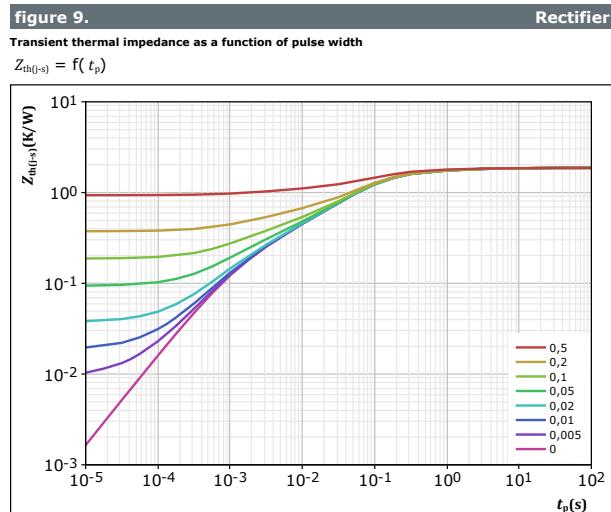
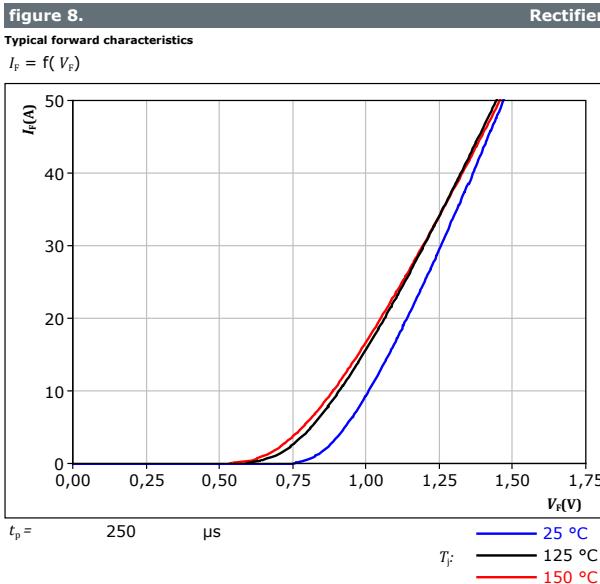
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## Boost Diode Characteristics





## Boost Sw. Protection Diode Characteristics



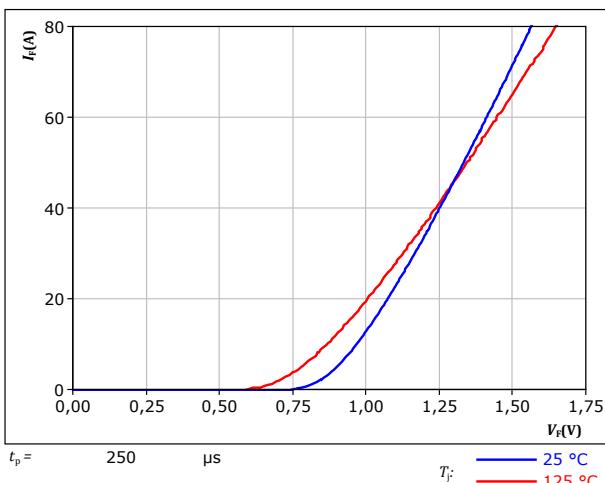


## ByPass Diode Characteristics

**figure 10.**

Typical forward characteristics

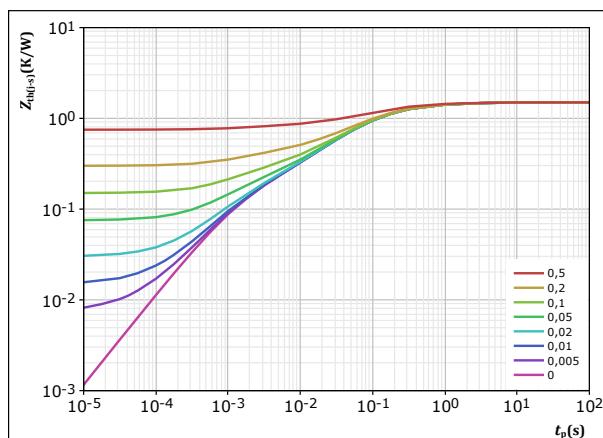
$$I_F = f(V_F)$$



**figure 11.**

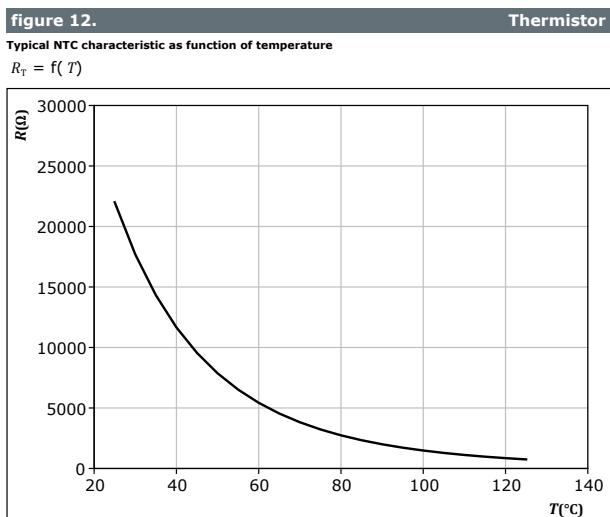
Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





## Thermistor Characteristics



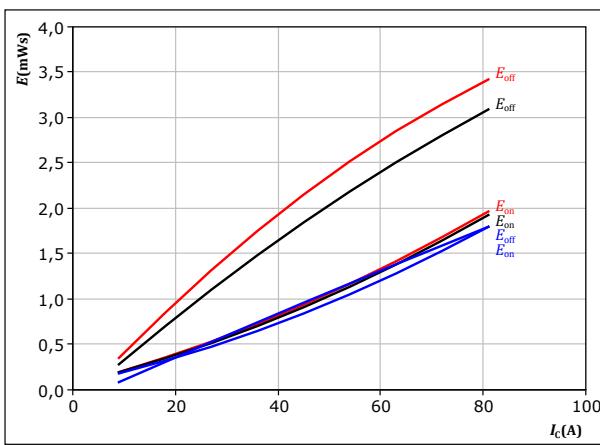


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## Boost Switching Characteristics

figure 13. IGBT

Typical switching energy losses as a function of collector current  
 $E = f(I_c)$

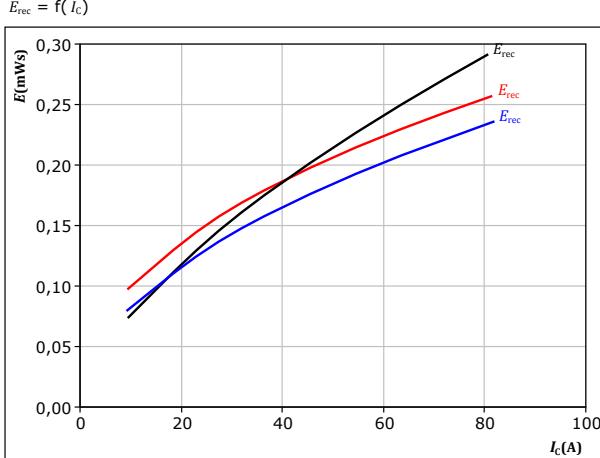


With an inductive load at

$V_{CE} = 700$  V       $T_f = 25^\circ\text{C}$   
 $V_{GE} = 0/15$  V       $T_f = 125^\circ\text{C}$   
 $R_{gon} = 4$  Ω       $T_f = 150^\circ\text{C}$   
 $R_{goff} = 4$  Ω

figure 15. FWD

Typical reverse recovered energy loss as a function of collector current  
 $E_{rec} = f(I_c)$

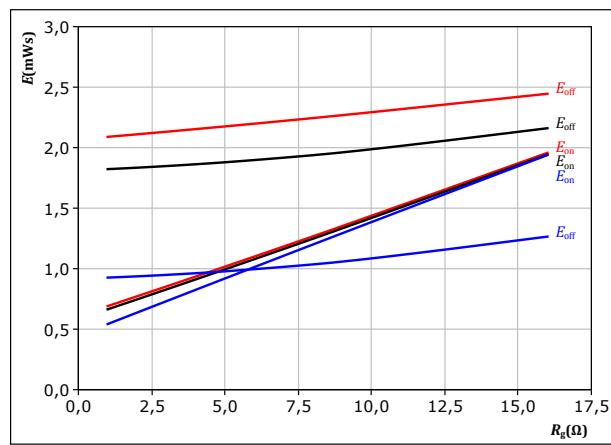


With an inductive load at

$V_{CE} = 700$  V       $T_f = 25^\circ\text{C}$   
 $V_{GE} = 0/15$  V       $T_f = 125^\circ\text{C}$   
 $R_{gon} = 4$  Ω       $T_f = 150^\circ\text{C}$

figure 14. IGBT

Typical switching energy losses as a function of gate resistor  
 $E = f(R_g)$

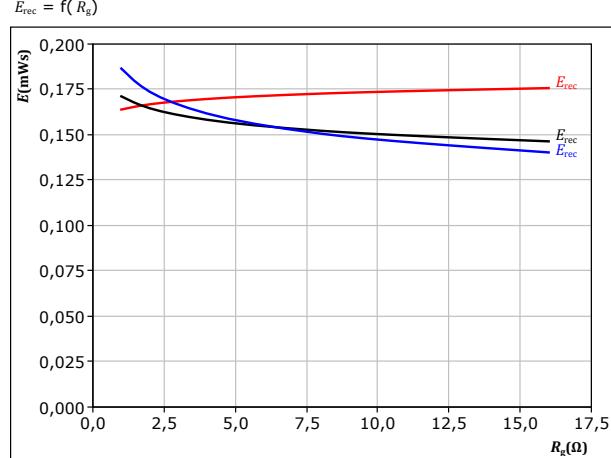


With an inductive load at

$V_{CE} = 700$  V       $T_f = 25^\circ\text{C}$   
 $V_{GE} = 0/15$  V       $T_f = 125^\circ\text{C}$   
 $I_c = 45$  A       $T_f = 150^\circ\text{C}$

figure 16. FWD

Typical reverse recovered energy loss as a function of gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at

$V_{CE} = 700$  V       $T_f = 25^\circ\text{C}$   
 $V_{GE} = 0/15$  V       $T_f = 125^\circ\text{C}$   
 $I_c = 45$  A       $T_f = 150^\circ\text{C}$

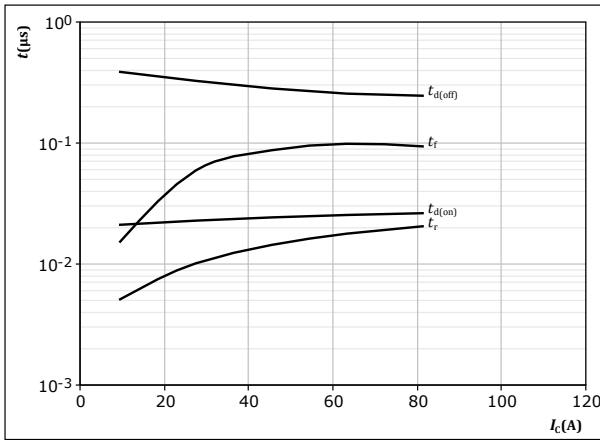


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## Boost Switching Characteristics

**figure 17.**

Typical switching times as a function of collector current  
 $t = f(I_C)$



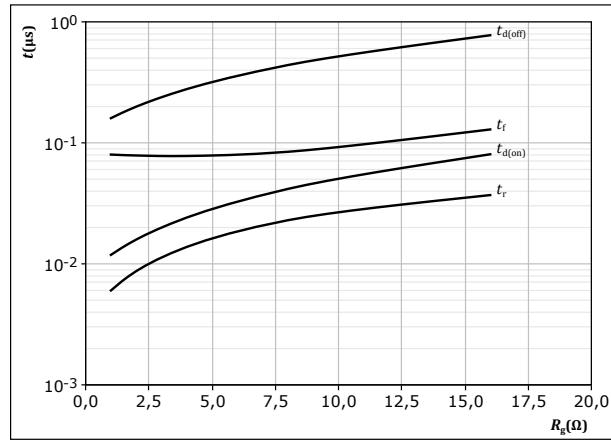
With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 700 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{gon} = 4 \Omega$   
 $R_{goff} = 4 \Omega$

**IGBT**

**figure 18.**

Typical switching times as a function of gate resistor  
 $t = f(R_g)$



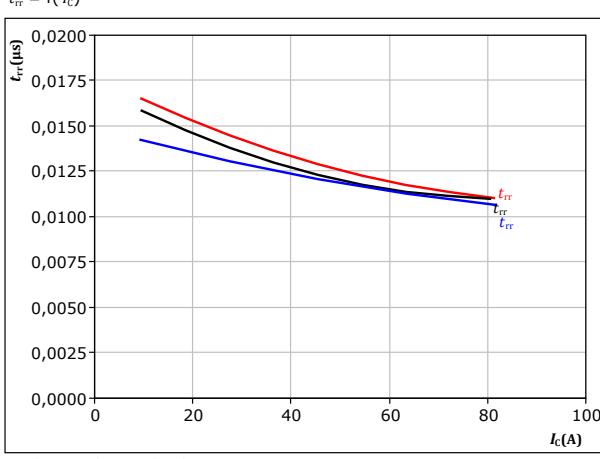
With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 700 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_C = 45 \text{ A}$

**IGBT**

**figure 19.**

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



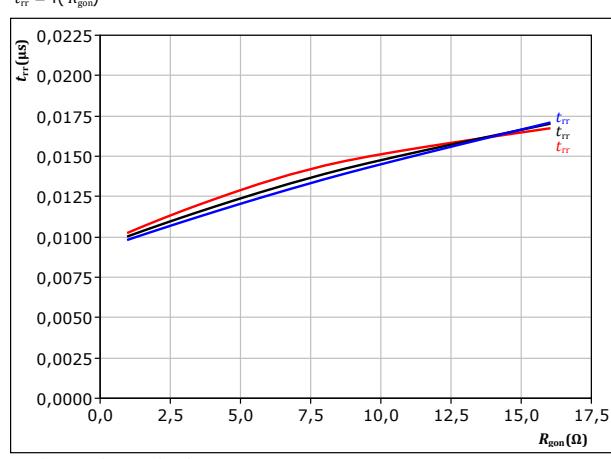
With an inductive load at

$V_{CE} = 700 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{gon} = 4 \Omega$

**FWD**

**figure 20.**

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 700 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_C = 45 \text{ A}$

$T_j: 25^\circ\text{C}, 125^\circ\text{C}, 150^\circ\text{C}$



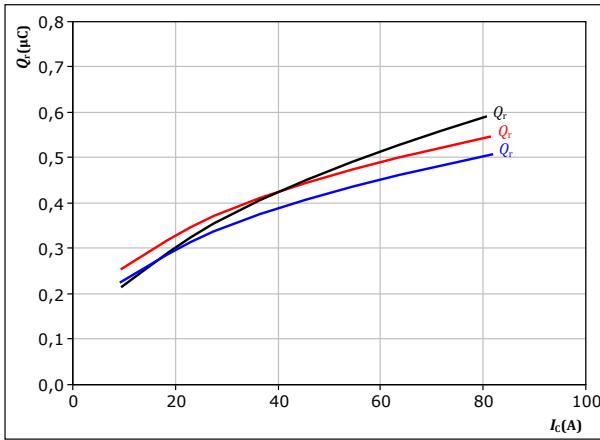
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## Boost Switching Characteristics

figure 21.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$

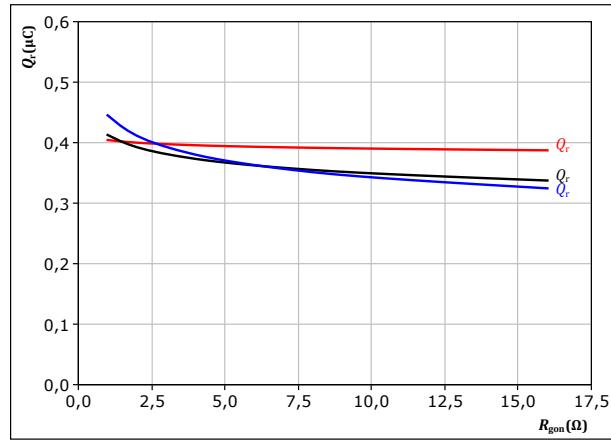


FWD

figure 22.

Typical recovered charge as a function of turn on gate resistor

$$Q_r = f(R_{gon})$$

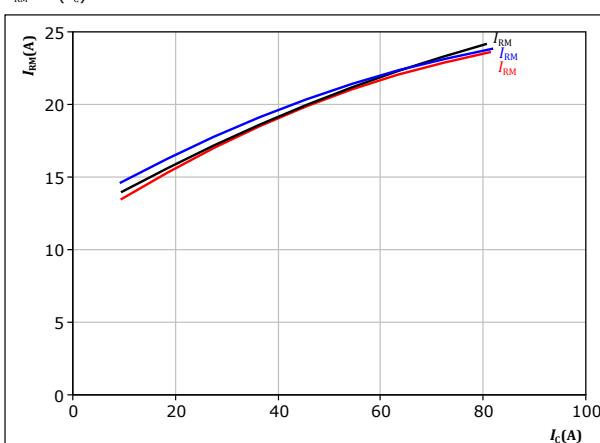


FWD

figure 23.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$

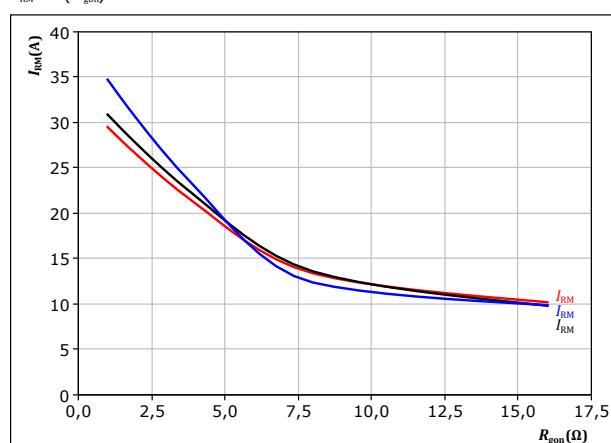


FWD

figure 24.

Typical peak reverse recovery current as a function of turn on gate resistor

$$I_{RM} = f(R_{gon})$$



FWD



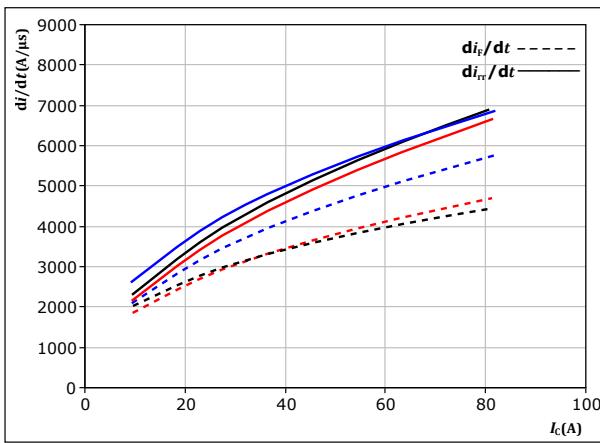
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## Boost Switching Characteristics

figure 25. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at

$V_{CE} = 700$  V

$T_j = 25^\circ\text{C}$

$V_{GE} = 0/15$  V

$R_{gon} = 4$  Ω

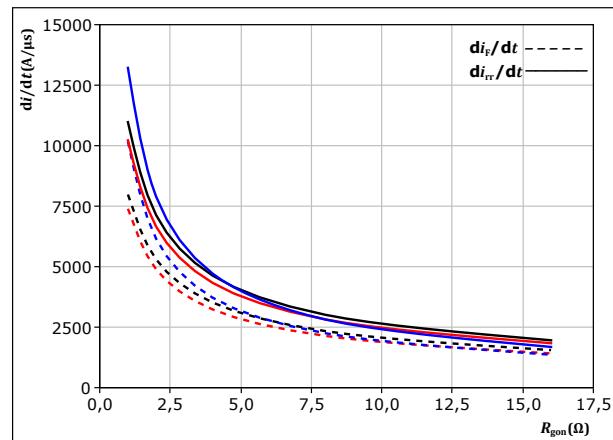
$T_j = 125^\circ\text{C}$

$T_j = 150^\circ\text{C}$

figure 26. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor

$di_f/dt, di_{rr}/dt = f(R_{gon})$



With an inductive load at

$V_{CE} = 700$  V

$V_{GE} = 0/15$  V

$I_c = 45$  A

$T_j = 25^\circ\text{C}$

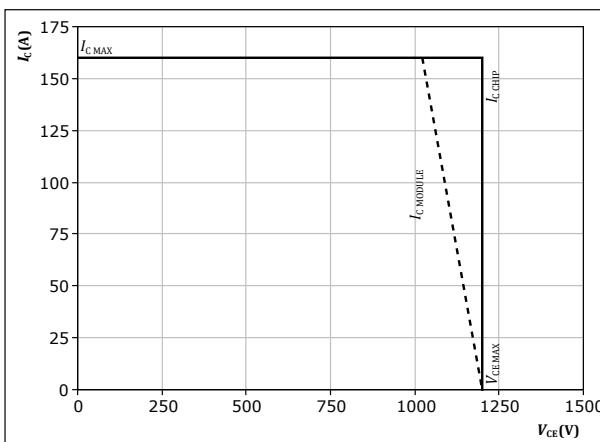
$T_j = 125^\circ\text{C}$

$T_j = 150^\circ\text{C}$

figure 27. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At  $T_j = 150^\circ\text{C}$

$R_{gon} = 4$  Ω

$R_{goff} = 4$  Ω

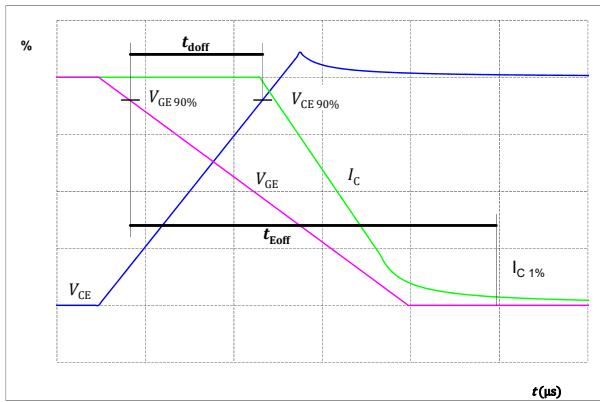


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## Boost Switching Definitions

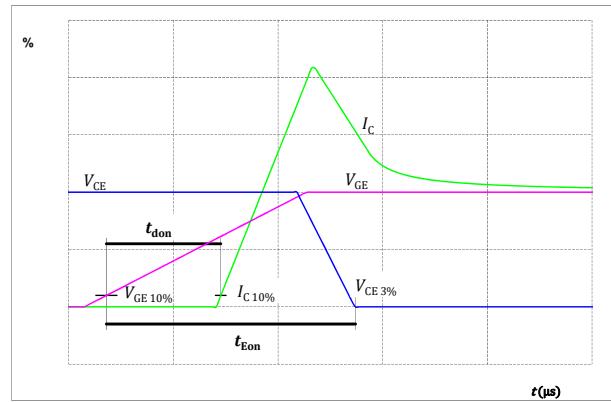
**figure 28.** IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



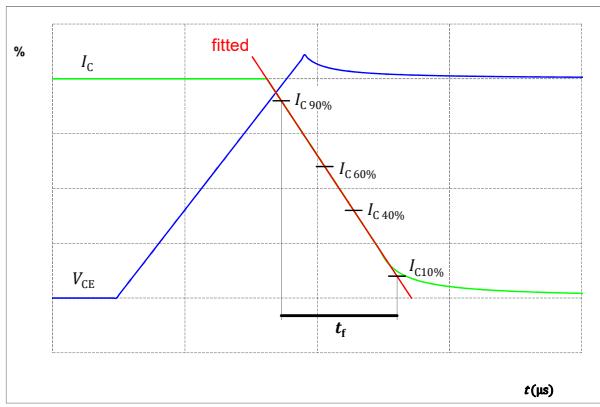
**figure 29.** IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



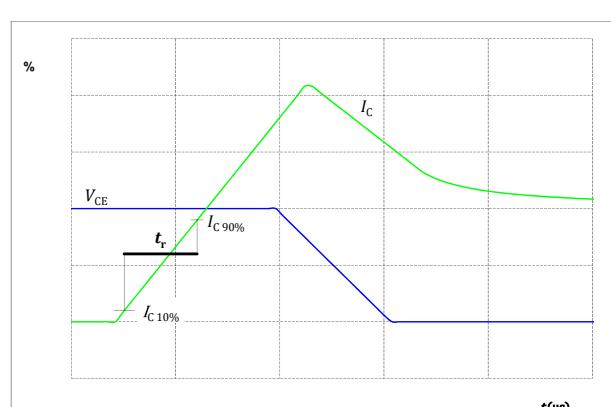
**figure 30.** IGBT

Turn-off Switching Waveforms & definition of  $t_f$



**figure 31.** IGBT

Turn-on Switching Waveforms & definition of  $t_r$





## Boost Switching Definitions

figure 32.

Turn-off Switching Waveforms & definition of  $t_{tr}$

FWD

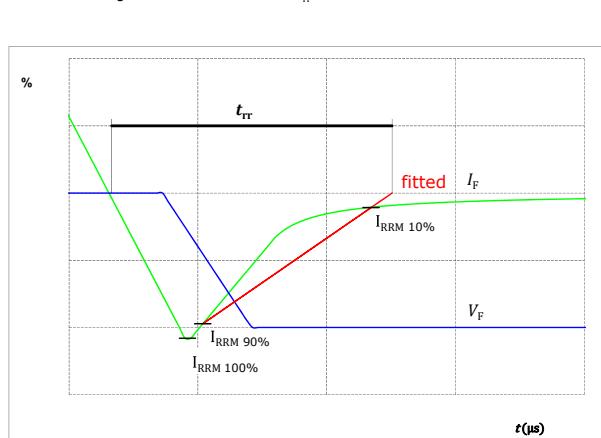
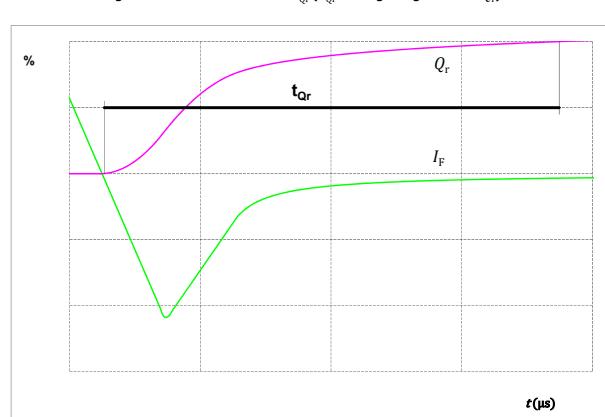


figure 33.

Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr}$  = integrating time for  $Q_r$ )

FWD



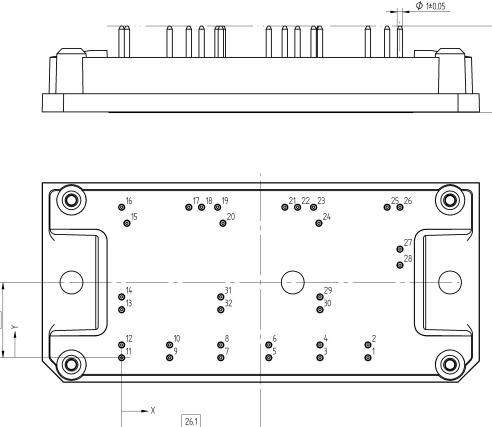
**10-FY123BA080N302-LN28L37**

datasheet

**Vincotech**

<b>Ordering Code</b>	
<b>Version</b>	<b>Ordering Code</b>
Without thermal paste	10-FY123BA080N302-LN28L37
With thermal paste	10-FY123BA080N302-LN28L37-/3/

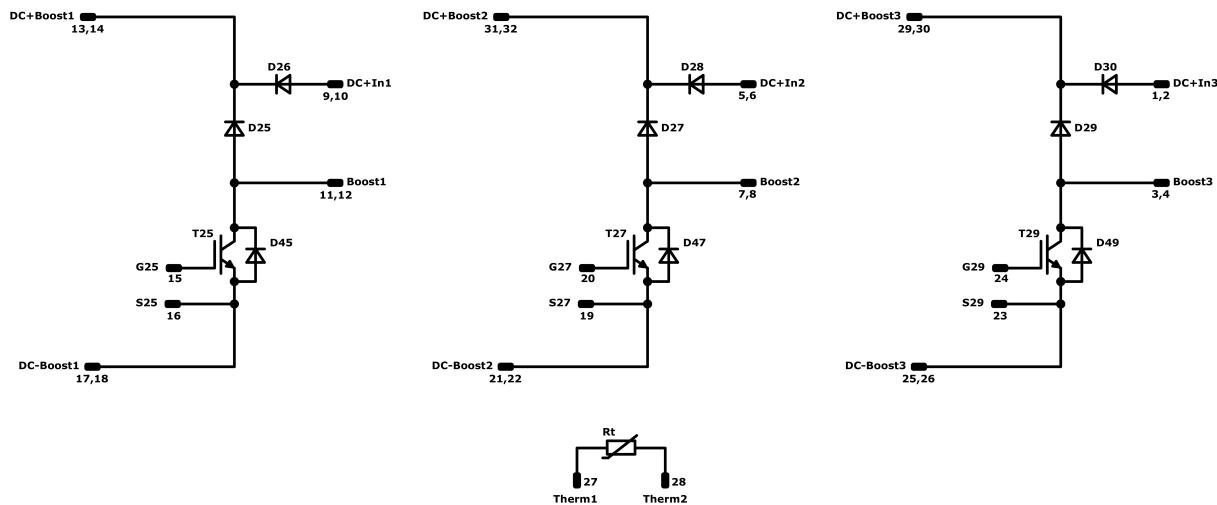
<b>Marking</b>						
 NNNNNNNNNNNNNN TTTTTTVVWWYY JL VIN LLLL SSSS	<b>Text</b>	<b>Name</b>	<b>Date code</b>	<b>UL &amp; VIN</b>	<b>Lot</b>	<b>Serial</b>
	Datamatrix	NN-NNNNNNNNNNNNNN- TTTTTTVV	WWYY	UL VIN	LLLLL	SSSS
Type&Ver	Lot number	Serial	Date code			

<b>Outline</b>							
<b>Pin table [mm]</b>							
Pin	X	Y	Function				
1	46,2	0	DC+In3				
2	46,2	2,4	DC+In3				
3	37,2	0	Boost3				
4	37,2	2,4	Boost3				
5	27,6	0	DC+In2				
6	27,6	2,4	DC+In2				
7	18,6	0	Boost2				
8	18,6	2,4	Boost2				
9	9	0	DC+In1				
10	9	2,4	DC+In1				
11	0	0	Boost1				
12	0	2,4	Boost1				
13	0	9	DC+Boost1				
14	0	11,4	DC+Boost1				
15	1	25,2	G25				
16	0	28,2	S25				
17	12,6	28,2	DC- Boost1				
18	15	28,2	DC- Boost1				
19	18	28,2	S27				
20	19	25,2	G27				
21	30,6	28,2	DC- Boost2				
22	33	28,2	DC- Boost2				
23	36	28,2	S29				
24	37	25,2	G29				
25	49,8	28,2	DC- Boost3				
26	52,2	28,2	DC- Boost3				
27	52,2	20,35	Therm1				
28	52,2	17,35	Therm2				
29	37,2	11,4	DC+Boost3				
30	37,2	9	DC+Boost3				
31	18,6	11,4	DC+Boost2				
32	18,6	9	DC+Boost2				



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### Pinout



### Identification

ID	Component	Voltage	Current	Function	Comment
T25, T27, T29	IGBT	1200 V	80 A	Boost Switch	
D25, D27, D29	FWD	1200 V	20 A	Boost Diode	
D45, D47, D49	Rectifier	1600 V	18 A	Boost Sw. Protection Diode	
D26, D28, D30	Rectifier	1600 V	28 A	ByPass Diode	
Rt	Thermistor			Thermistor	

**10-FY123BA080N302-LN28L37**

datasheet

**Vincotech****Packaging instruction**

Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
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**Handling instruction**

Handling instructions for flow 1 packages see vincotech.com website.

**Package data**

Package data for flow 1 packages see vincotech.com website.

**UL recognition and file number**

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-FY123BA080N302-LN28L37-D1-14	5 Dec. 2019	Initial Release	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.